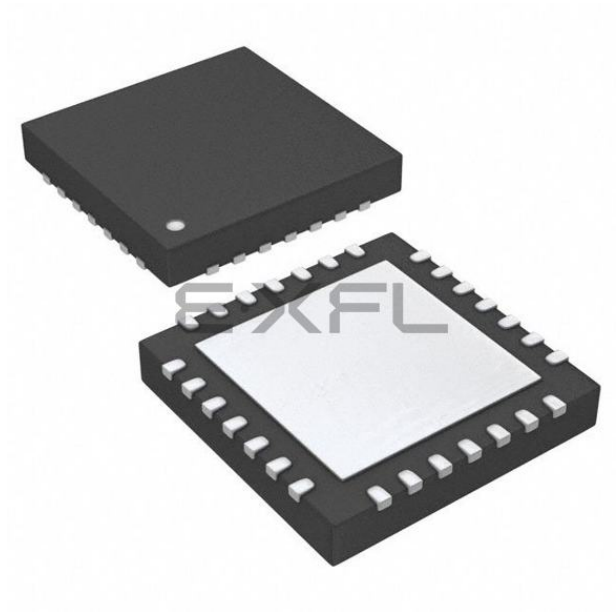

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Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	25
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 24x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-UFQFN Exposed Pad
Supplier Device Package	28-UQFN (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f18855-e-mv

TABLE 3-11: PIC16(L)F18875 MEMORY MAP, BANK 30

	Bank 30
F0Ch	—
F0Dh	—
F0Eh	—
F0Fh	—
F10h	RA0PPS
F11h	RA1PPS
F12h	RA2PPS
F13h	RA3PPS
F14h	RA4PPS
F15h	RA5PPS
F16h	RA6PPS
F17h	RA7PPS
F18h	RB0PPS
F19h	RB1PPS
F1Ah	RB2PPS
F1Bh	RB3PPS
F1Ch	RB4PPS
F1Dh	RB5PPS
F1Eh	RB6PPS
F1Fh	RB7PPS
F20h	RC0PPS
F21h	RC1PPS
F22h	RC2PPS
F23h	RC3PPS
F24h	RC4PPS
F25h	RC5PPS
F26h	RC6PPS
F27h	RC7PPS
F28h — F37h	—
F38h	ANSELA
F39h	WPUA
F3Ah	ODCONA
F3Bh	SLRCONA
F3Ch	INLVLA
F3Dh	IOCAP
F3Eh	IOCAN
F3Fh	IOCAF

	Bank 30
F40h	CCDNA
F41h	CCDPA
F42h	—
F43h	ANSELB
F44h	WPUB
F45h	ODCONB
F46h	SLRCONB
F47h	INLVLB
F48h	IOCBP
F49h	IOCBN
F4Ah	IOCBF
F4Bh	CCDNB
F4Ch	CCDPB
F4Dh	—
F4Eh	ANSELC
F4Fh	WPUC
F50h	ODCONC
F51h	SLRCONC
F52h	INLVLC
F53h	IOCCP
F54h	IOCCN
F55h	IOCCF
F56h	CCDNC
F57h	CCDPC
F58h	—
F59h	ANSELD
F5Ah	WPUD
F5Bh	ODCOND
F5Ch	SLRCOND
F5Dh	INLVLD
F5Eh	—
F5Fh	—
F60h	—
F61h	CCDND
F62h	CCDPD
F63h	—

	Bank 30
F64h	ANSELE
F65h	WPUE
F66h	ODCONE
F67h	SLRCONE
F68h	INLVLE
F69h	IOCEP
F6Ah	IOCEN
F6Bh	IOCEF
F6Ch	CCDNE
F6Dh	CCDPE
F6Eh	—
F6Fh	—

Legend: = Unimplemented data memory locations, read as '0'.

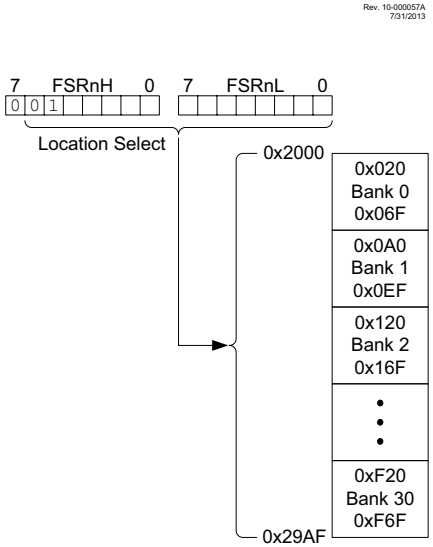
3.5.2 LINEAR DATA MEMORY

The linear data memory is the region from FSR address 0x2000 to FSR address 0x29AF. This region is a virtual region that points back to the 80-byte blocks of GPR memory in all the banks.

Unimplemented memory reads as 0x00. Use of the linear data memory region allows buffers to be larger than 80 bytes because incrementing the FSR beyond one bank will go directly to the GPR memory of the next bank.

The 16 bytes of common memory are not included in the linear data memory region.

FIGURE 3-10: TRADITIONAL DATA MEMORY MAP



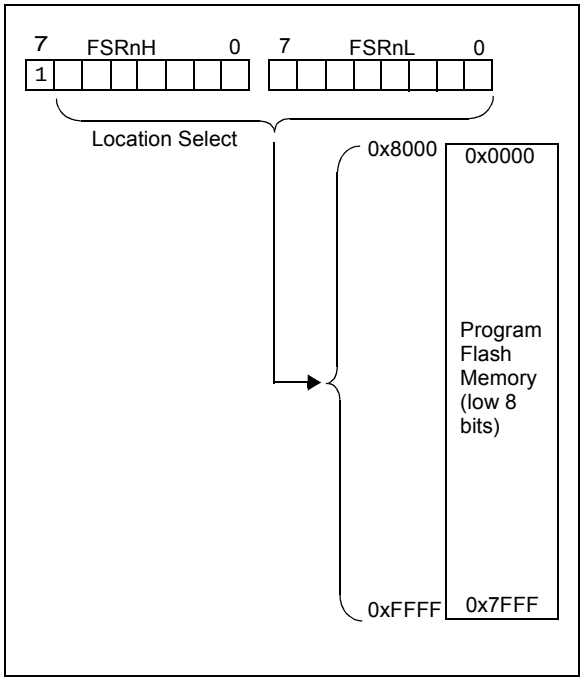
3.5.3 DATA EEPROM MEMORY

The EEPROM memory can be read or written through the NVMCONx/NVMADRx/NVMDATx register interface (see section **Section 10.2 "Data EEPROM Memory"**). However, to make access to the EEPROM memory easier, read-only access to the EEPROM contents are also available through indirect addressing by an FSR. When the MSB of the FSR (ex: FSRxH) is set to 0x70, the lower 8-bit address value (in FSRxL) determines the EEPROM location that may be read from (through the INDF register). In other words, the EEPROM address range 0x00-0xFF is mapped into the FSR address space between 0x7000-0x70FF. Writing to the EEPROM cannot be accomplished via the FSR/INDF interface. Reads from the EEPROM through the FSR/INDF interface will require one additional instruction cycle to complete.

3.5.4 PROGRAM FLASH MEMORY

To make constant data access easier, the entire Program Flash Memory is mapped to the upper half of the FSR address space. When the MSB of FSRnH is set, the lower 15 bits are the address in program memory which will be accessed through INDF. Only the lower eight bits of each memory location is accessible via INDF. Writing to the Program Flash Memory cannot be accomplished via the FSR/INDF interface. All instructions that access Program Flash Memory via the FSR/INDF interface will require one additional instruction cycle to complete.

FIGURE 3-11: PROGRAM FLASH MEMORY MAP



4.0 DEVICE CONFIGURATION

Device configuration consists of Configuration Words, Code Protection and Device ID.

4.1 Configuration Words

There are several Configuration Word bits that allow different oscillator and memory protection options. These are implemented as shown in Table 4-1.

TABLE 4-1: CONFIGURATION WORD LOCATIONS

Configuration Word	Location
CONFIG1	8007h
CONFIG2	8008h
CONFIG3	8009h
CONFIG4	800Ah
CONFIG5	800Bh

Note: The $\overline{\text{DEBUG}}$ bit in Configuration Words is managed automatically by device development tools including debuggers and programmers. For normal device operation, this bit should be maintained as a '1'.

REGISTER 4-3: CONFIG3: CONFIGURATION WORD 3: WINDOWED WATCHDOG

R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
WDTCCS<2:0>			WDTCWS<2:0>		
bit 13					bit 8

U-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
	WDTE<1:0>		WDTCPS<4:0>				
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	x = Bit is unknown	U = Unimplemented bit, read as ‘1’
‘0’ = Bit is cleared	‘1’ = Bit is set	W = Writable bit	n = Value when blank or after Bulk Erase

bit 13-11 **WDTCCS<2:0>**: WDT Input Clock Selector bits
- 111 = Software Control
- 110 = Reserved
- .
- .
- .
- 010 = Reserved
- 001 = WDT reference clock is the MFINTOSC/16 output (31.25 kHz)
- 000 = WDT reference clock is the 31.0 kHz LFINTOSC (default value)

bit 10-8 **WDTCWS<2:0>**: WDT Window Select bits

WDTCWS	WDTWS at POR			Software control of WDTWS?	Keyed access required?
	Value	Window delay Percent of time	Window opening Percent of time		
111	111	n/a	100	Yes	No
110	111	n/a	100	No	Yes
101	101	25	75		
100	100	37.5	62.5		
011	011	50	50		
010	010	62.5	37.5		
001	001	75	25		
000	000	87.5	12.5		

bit 7 **Unimplemented**: Read as ‘1’

bit 6-5 **WDTE<1:0>**: WDT Operating mode:
- 11 = WDT enabled regardless of Sleep; SWDTEN is ignored
- 10 = WDT enabled while Sleep = 0, suspended when Sleep = 1; SWDTEN ignored
- 01 = WDT enabled/disabled by SWDTEN bit in WDTCON0
- 00 = WDT disabled, SWDTEN is ignored

11.11 Register Definitions: CRC and Scanner Control

REGISTER 11-1: CRCCON0: CRC CONTROL REGISTER 0

R/W-0/0	R/W-0/0	R-0	R/W-0/0	U-0	U-0	R/W-0/0	R-0
EN	CRCGO	BUSY	ACCM	—	—	SHIFTM	FULL
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **EN:** CRC Enable bit
1 = CRC module is released from Reset
0 = CRC is disabled and consumes no operating current

bit 6 **CRCGO:** CRC Start bit
1 = Start CRC serial shifter
0 = CRC serial shifter turned off

bit 5 **BUSY:** CRC Busy bit
1 = Shifting in progress or pending
0 = All valid bits in shifter have been shifted into accumulator and EMPTY = 1

bit 4 **ACCM:** Accumulator Mode bit
1 = Data is augmented with zeros
0 = Data is not augmented with zeros

bit 3-2 **Unimplemented:** Read as ‘0’

bit 1 **SHIFTM:** Shift Mode bit
1 = Shift right (LSb)
0 = Shift left (MSb)

bit 0 **FULL:** Data Path Full Indicator bit
1 = CRCDATH/L registers are full
0 = CRCDATH/L registers have shifted their data into the shifter

REGISTER 11-2: CRCCON1: CRC CONTROL REGISTER 1

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
DLEN<3:0>				PLEN<3:0>			
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-4 **DLEN<3:0>:** Data Length bits
Denotes the length of the data word -1 (See Example 11-1)

bit 3-0 **PLEN<3:0>:** Polynomial Length bits
Denotes the length of the polynomial -1 (See Example 11-1)

REGISTER 12-49: WPUE: WEAK PULL-UP PORTE REGISTER

U-0	U-0	U-0	U-0	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
—	—	—	—	WPUE3	WPUE2	WPUE1	WPUE0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-4 **Unimplemented:** Read as '0'

bit 3-0 **WPUE<3:0>** Weak Pull-up Register bit(1)
1 = Pull-up enabled
0 = Pull-up disabled

Note 1: The weak pull-up device is automatically disabled if the pin is configured as an output.

REGISTER 12-50: ODCONE: PORTE OPEN-DRAIN CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	—	—	ODCE2	ODCE1	ODCE0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-3 **Unimplemented:** Read as '0'

bit 2-0 **ODCE<2:0>:** PORTE Open-Drain Enable bits
For RE<2:0> pins, respectively
1 = Port pin operates as open-drain drive (sink current only)
0 = Port pin operates as standard push-pull drive (source and sink current)

FIGURE 20-13: SHUTDOWN FUNCTIONALITY, AUTO-RESTART DISABLED (REN = 0, LSAC = 01, LSBD = 01)

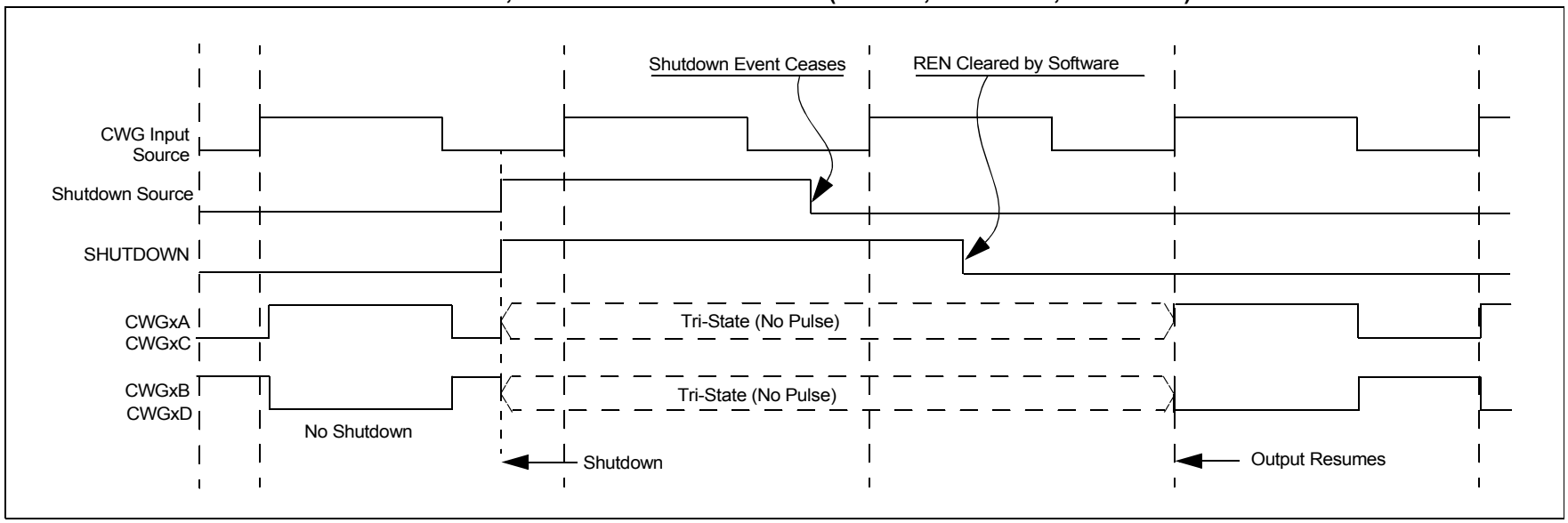


FIGURE 20-14: SHUTDOWN FUNCTIONALITY, AUTO-RESTART ENABLED (REN = 1, LSAC = 01, LSBD = 01)

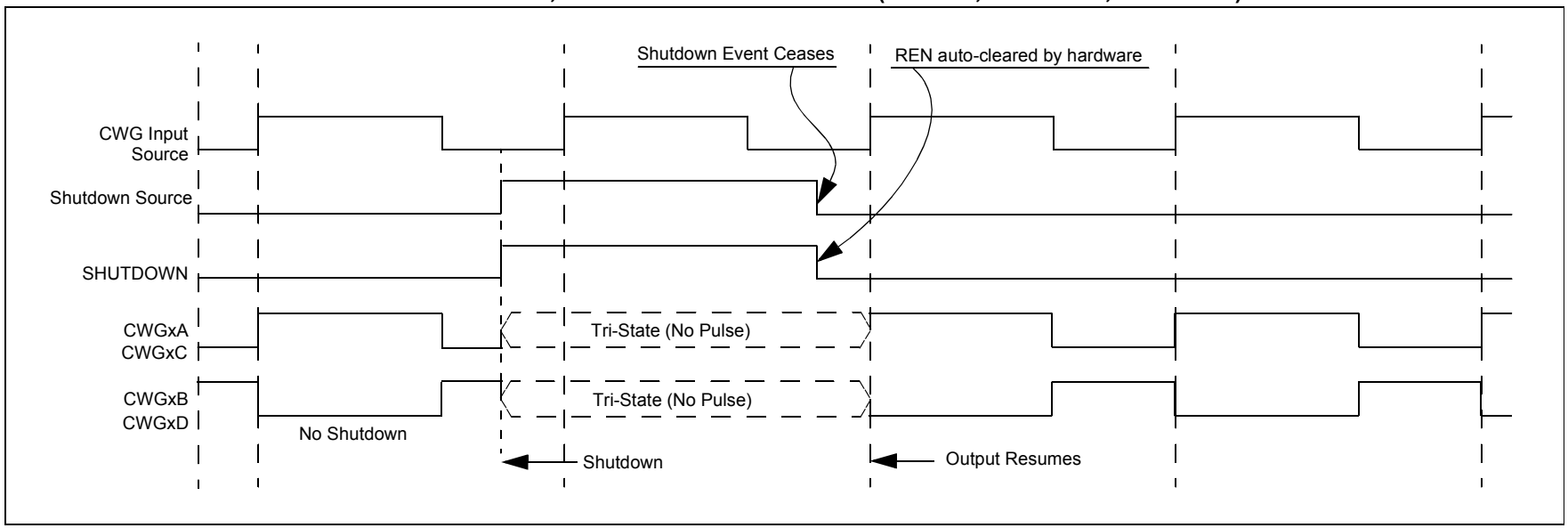
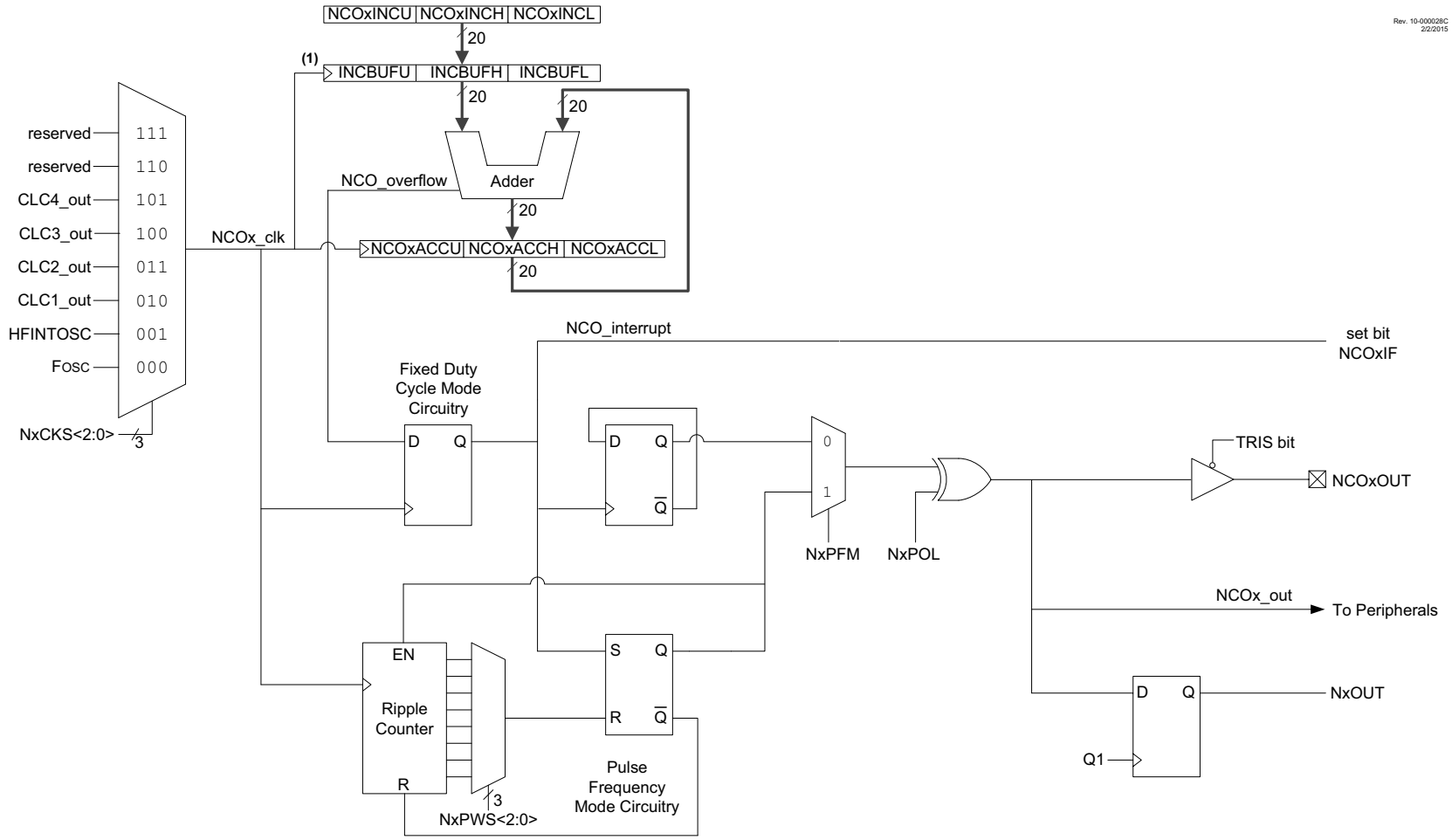


FIGURE 24-1: DIRECT DIGITAL SYNTHESIS MODULE SIMPLIFIED BLOCK DIAGRAM



Note 1: The increment registers are double-buffered to allow for value changes to be made without first disabling the NCO module. The full increment value is loaded into the buffer registers on the second rising edge of the NCOx_clk signal that occurs immediately after a write to NCOxINCL register. The buffers are not user-accessible and are shown here for reference.

24.8 NCO Control Registers

REGISTER 24-1: NCO1CON: NCO CONTROL REGISTER

R/W-0/0	U-0	R-0/0	R/W-0/0	U-0	U-0	U-0	R/W-0/0
N1EN	—	N1OUT	N1POL	—	—	—	N1PFM
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **N1EN:** NCO1 Enable bit
1 = NCO1 module is enabled
0 = NCO1 module is disabled

bit 6 **Unimplemented**: Read as ‘0’

bit 5 **N1OUT:** NCO1 Output bit
Displays the current output value of the NCO1 module.

bit 4 **N1POL:** NCO1 Polarity
1 = NCO1 output signal is inverted
0 = NCO1 output signal is not inverted

bit 3-1 **Unimplemented**: Read as ‘0’

bit 0 **N1PFM:** NCO1 Pulse Frequency Mode bit
1 = NCO1 operates in Pulse Frequency mode
0 = NCO1 operates in Fixed Duty Cycle mode, divide by 2

REGISTER 26-4: MDCARH: MODULATION HIGH CARRIER CONTROL REGISTER

U-0	U-0	U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	—	—	MDCHS<3:0>(1)			
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-4 **Unimplemented:** Read as '0'

bit 3-0 **MDCHS<3:0>** Modulator Data High Carrier Selection bits (1)

1111 = LC4_out
1110 = LC3_out
1101 = LC2_out
1100 = LC1_out
1011 = NCO output
1010 = PWM7_out
1001 = PWM6_out
1000 = CCP5 output (PWM Output mode only)
0111 = CCP4 output (PWM Output mode only)
0110 = CCP3 output (PWM Output mode only)
0101 = CCP2 output (PWM Output mode only)
0100 = CCP1 output (PWM Output mode only)
0011 = Reference clock module signal (CLKR)
0010 = HFINTOSC
0001 = FOSC
0000 = Pin selected by MDCARHPPS

Note 1: Narrowed carrier pulse widths or spurs may occur in the signal stream if the carrier is not synchronized.

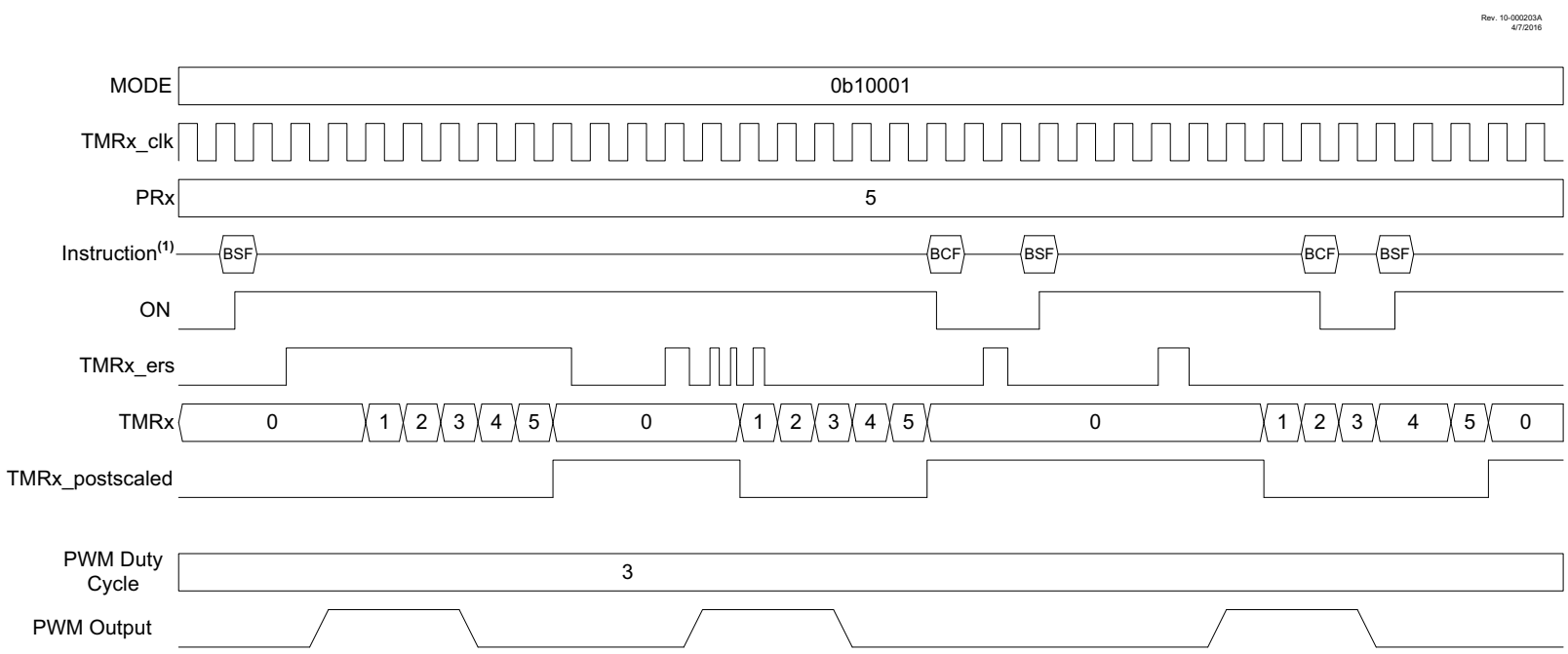
29.5.9 EDGE-TRIGGERED MONOSTABLE MODES

The Edge-Triggered Monostable modes start the timer on an edge from the external Reset signal input, after the ON bit is set, and stop incrementing the timer when the timer matches the PRx period value. The following edges will start the timer:

- Rising edge (MODE<4:0> = 10001)
- Falling edge (MODE<4:0> = 10010)
- Rising or Falling edge (MODE<4:0> = 10011)

When an Edge-Triggered Monostable mode is used in conjunction with the CCP PWM operation the PWM drive goes active with the external Reset signal edge that starts the timer, but will not go active when the timer matches the PRx value. While the timer is incrementing, additional edges on the external Reset signal will not affect the CCP PWM.

FIGURE 29-12: RISING EDGE-TRIGGERED MONOSTABLE MODE TIMING DIAGRAM (MODE = 10001)



Note 1: BSF and BCF represent Bit-Set File and Bit-Clear File instructions executed by the CPU to set or clear the ON bit of TxCON. CPU execution is asynchronous to the timer clock input.

REGISTER 30-1: CCPxCON: CCPx CONTROL REGISTER (CONTINUED)

bit 3-0 **MODE<3:0>:** CCPx Mode Select bits(1)

1111 = PWM mode
1110 = Reserved
1101 = Reserved
1100 = Reserved

1011 = Compare mode: output will pulse 0-1-0; Clears TMR1
1010 = Compare mode: output will pulse 0-1-0
1001 = Compare mode: clear output on compare match
1000 = Compare mode: set output on compare match

0111 = Capture mode: every 16th rising edge of CCPx input
0110 = Capture mode: every 4th rising edge of CCPx input
0101 = Capture mode: every rising edge of CCPx input
0100 = Capture mode: every falling edge of CCPx input

0011 = Capture mode: every edge of CCPx input
0010 = Compare mode: toggle output on match
0001 = Compare mode: toggle output on match; clear TMR1
0000 = Capture/Compare/PWM off (resets CCPx module)

Note 1: All modes will set the CCPxIF bit, and will trigger an ADC conversion if CCPx is selected as the ADC trigger source.

31.2.2 SPI MODE OPERATION

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits (SSPxCON1<3:0> and SSPxSTAT<7:6>). These control bits allow the following to be specified:

- Master mode (SCK is the clock output)
- Slave mode (SCK is the clock input)
- Clock Polarity (Idle state of SCK)
- Data Input Sample Phase (middle or end of data output time)
- Clock Edge (output data on rising/falling edge of SCK)
- Clock Rate (Master mode only)
- Slave Select mode (Slave mode only)

To enable the serial port, SSP Enable bit, SSPEN of the SSPxCON1 register, must be set. To reset or reconfigure SPI mode, clear the SSPEN bit, re-initialize the SSPxCONx registers and then set the SSPEN bit. This configures the SDI, SDO, SCK and $\overline{SS}$ pins as serial port pins. For the pins to behave as the serial port function, some must have their data direction bits (in the TRISx register) appropriately programmed as follows:

- SDI must have corresponding TRIS bit set
- SDO must have corresponding TRIS bit cleared
- SCK (Master mode) must have corresponding TRIS bit cleared
- SCK (Slave mode) must have corresponding TRIS bit set
- $\overline{SS}$ must have corresponding TRIS bit set

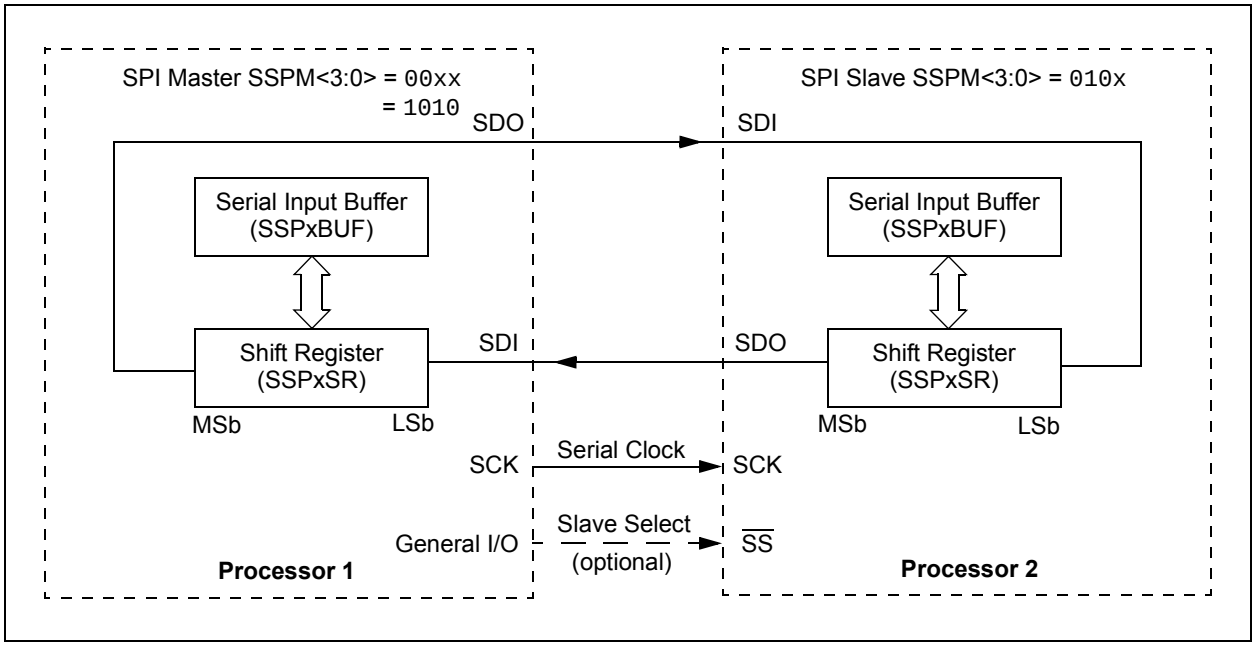
Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value.

The MSSP consists of a transmit/receive shift register (SSPxSR) and a buffer register (SSPxBUF). The SSPxSR shifts the data in and out of the device, MSb first. The SSPxBUF holds the data that was written to the SSPxSR until the received data is ready. Once the eight bits of data have been received, that byte is moved to the SSPxBUF register. Then, the Buffer Full Detect bit, BF of the SSPxSTAT register, and the interrupt flag bit, SSPxIF, are set. This double-buffering of the received data (SSPxBUF) allows the next byte to start reception before reading the data that was just received. Any write to the SSPxBUF register during transmission/reception of data will be ignored and the write collision detect bit WCOL of the SSPxCON1 register, will be set. User software must clear the WCOL bit to allow the following write(s) to the SSPxBUF register to complete successfully.

When the application software is expecting to receive valid data, the SSPxBUF should be read before the next byte of data to transfer is written to the SSPxBUF. The Buffer Full bit, BF of the SSPxSTAT register, indicates when SSPxBUF has been loaded with the received data (transmission is complete). When the SSPxBUF is read, the BF bit is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally, the MSSP interrupt is used to determine when the transmission/reception has completed. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur.

The SSPxSR is not directly readable or writable and can only be accessed by addressing the SSPxBUF register. Additionally, the SSPxSTAT register indicates the various Status conditions.

FIGURE 31-5: SPI MASTER/SLAVE CONNECTION



31.5.3.3 7-bit Transmission with Address Hold Enabled

Setting the AHEN bit of the SSPxCON3 register enables additional clock stretching and interrupt generation after the eighth falling edge of a received matching address. Once a matching address has been clocked in, CKP is cleared and the SSPxIF interrupt is set.

Figure 31-19 displays a standard waveform of a 7-bit address slave transmission with AHEN enabled.

1. Bus starts Idle.
2. Master sends Start condition; the S bit of SSPxSTAT is set; SSPxIF is set if interrupt on Start detect is enabled.
3. Master sends matching address with R/$\overline{W}$ bit set. After the eighth falling edge of the SCL line the CKP bit is cleared and SSPxIF interrupt is generated.
4. Slave software clears SSPxIF.
5. Slave software reads ACKTIM bit of SSPxCON3 register, and R/$\overline{W}$ and D/$\overline{A}$ of the SSPxSTAT register to determine the source of the interrupt.
6. Slave reads the address value from the SSPxBUF register clearing the BF bit.
7. Slave software decides from this information if it wishes to $\overline{ACK}$ or not $\overline{ACK}$ and sets the ACKDT bit of the SSPxCON2 register accordingly.
8. Slave sets the CKP bit releasing SCL.
9. Master clocks in the $\overline{ACK}$ value from the slave.
10. Slave hardware automatically clears the CKP bit and sets SSPxIF after the $\overline{ACK}$ if the R/$\overline{W}$ bit is set.
11. Slave software clears SSPxIF.
12. Slave loads value to transmit to the master into SSPxBUF setting the BF bit.

Note: SSPxBUF cannot be loaded until after the $\overline{ACK}$.

13. Slave sets the CKP bit releasing the clock.
14. Master clocks out the data from the slave and sends an $\overline{ACK}$ value on the ninth SCL pulse.
15. Slave hardware copies the $\overline{ACK}$ value into the ACKSTAT bit of the SSPxCON2 register.
16. Steps 10-15 are repeated for each byte transmitted to the master from the slave.
17. If the master sends a not $\overline{ACK}$ the slave releases the bus allowing the master to send a Stop and end the communication.

Note: Master must send a not $\overline{ACK}$ on the last byte to ensure that the slave releases the SCL line to receive a Stop.

32.6.2 GATED TIMER MODE

Gated Timer mode uses the SMTSIGx input to control whether or not the SMTxTMR will increment. Upon a falling edge of the external signal, the SMTxCPW register will update to the current value of the SMTxTMR. Example waveforms for both repeated and single acquisitions are provided in Figure 32-4 and Figure 32-5.

32.6.5 WINDOWED MEASURE MODE

This mode measures the window duration of the SMTWINx input of the SMT. It begins incrementing the timer on a rising edge of the SMTWINx input and updates the SMTxCPR register with the value of the timer and resets the timer on a second rising edge. See Figure 32-10 and Figure 32-11.

FIGURE 32-10: WINDOWED MEASURE MODE REPEAT ACQUISITION TIMING DIAGRAM

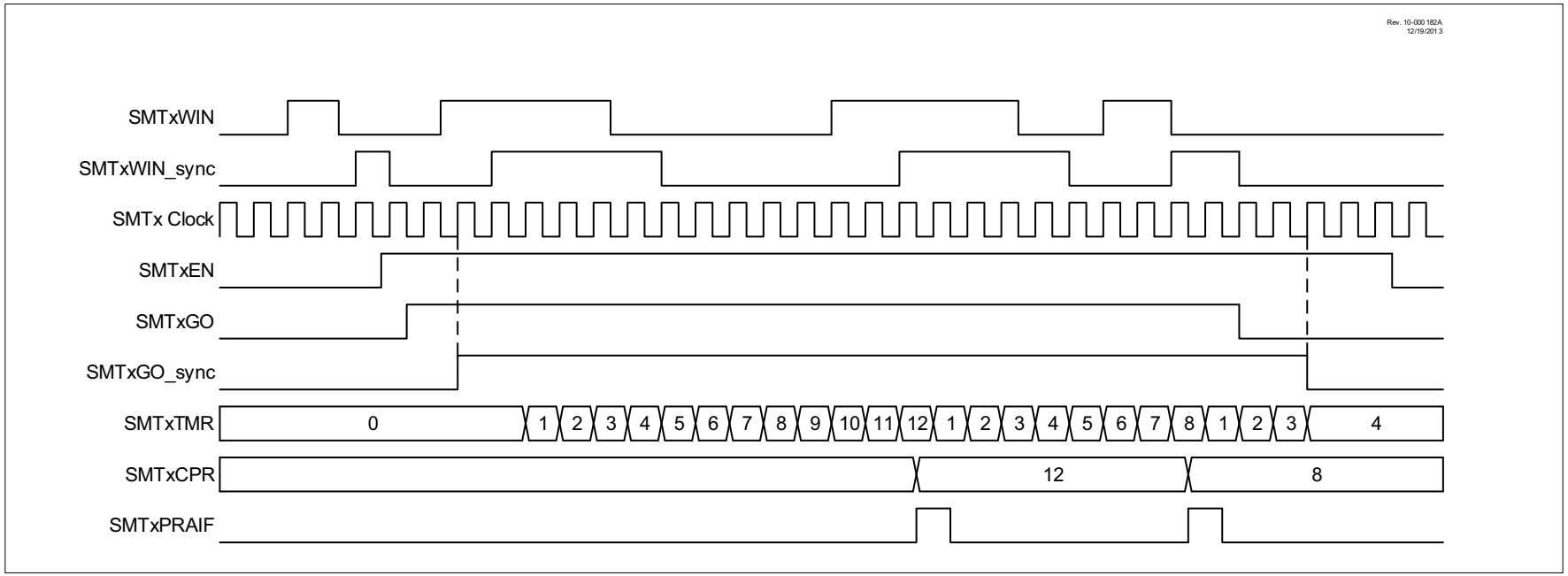
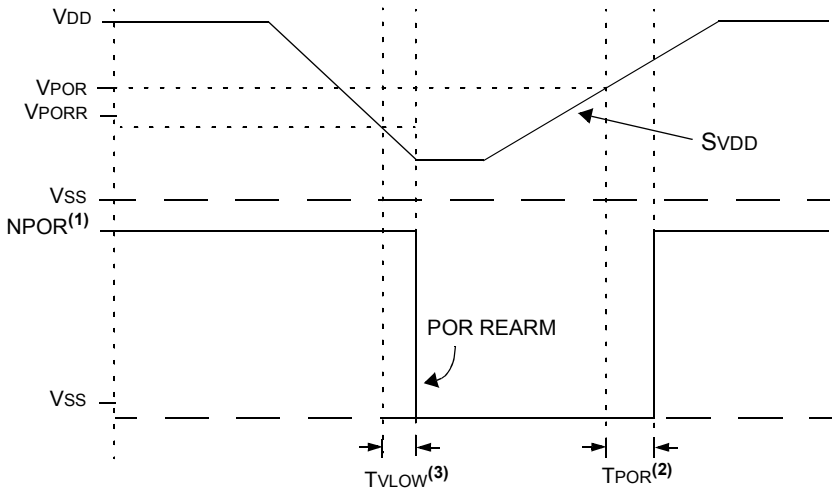


FIGURE 37-3: POR AND POR REARM WITH SLOW RISING VDD



Note 1: When NPOR is low, the device is held in Reset.
2: TPOR 1 μs typical.
3: TVLOW 2.7 μs typical.

TABLE 37-11: RESET, WDT, OSCILLATOR START-UP TIMER, POWER-UP TIMER, BROWN-OUT RESET AND LOW-POWER BROWN-OUT RESET SPECIFICATIONS

Standard Operating Conditions (unless otherwise stated)							
Param. No.	**Sym.**	**Characteristic**	**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
RST01*	TMCLR	$\overline{\text{MCLR}}$ Pulse Width Low to ensure Reset	2	—	—	µs	
RST02*	TIOZ	I/O high-impedance from Reset detection	—	—	2	µs	
RST03	TWDT	Watchdog Timer Time-out Period	—	16	—	ms	16 ms Nominal Reset Time
RST04*	TPWRT	Power-up Timer Period	—	65	—	ms	
RST05	TOST	Oscillator Start-up Timer Period(1,2)	—	1024	—	TOSC	
RST06	VBOR	Brown-out Reset Voltage(4)	2.55 2.30 1.80	2.70 2.45 1.90	2.85 2.60 2.10	V V V	BORV = 0 BORV = 1 (PIC16F18855/75) BORV = 1 (PIC16LF18855/75)
RST07	VBORHYS	Brown-out Reset Hysteresis	—	40	—	mV	
RST08	TBORDC	Brown-out Reset Response Time	—	3	—	µs	
RST09	VLPBOR	Low-Power Brown-out Reset Voltage	2.3	2.45	2.7	V	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: By design, the Oscillator Start-up Timer (OST) counts the first 1024 cycles, independent of frequency.

2: To ensure these voltage tolerances, VDD and VSS must be capacitively decoupled as close to the device as possible. 0.1 µF and 0.01 µF values in parallel are recommended.

TABLE 37-12: ANALOG-TO-DIGITAL CONVERTER (ADC) ACCURACY SPECIFICATIONS(1,2):

Operating Conditions (unless otherwise stated) VDD = 3.0V, TA = 25°C							
Param. No.	**Sym.**	**Characteristic**	**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
AD01	NR	Resolution	—	—	10	bit	
AD02	EIL	Integral Error	—	±0.1	±1.0	LSb	ADCREF+ = 3.0V, ADCREF-= 0V
AD03	EDL	Differential Error	—	±0.1	±1.0	LSb	ADCREF+ = 3.0V, ADCREF-= 0V
AD04	EOFF	Offset Error	—	0.5	2.0	LSb	ADCREF+ = 3.0V, ADCREF-= 0V
AD05	EGN	Gain Error	—	±0.2	±1.0	LSb	ADCREF+ = 3.0V, ADCREF-= 0V
AD06	VADREF	ADC Reference Voltage (ADREF+ - ADREF-)	1.8	—	VDD	V	
AD07	VAIN	Full-Scale Range	ADREF-	—	ADREF+	V	
AD08	ZAIN	Recommended Impedance of Analog Voltage Source	—	10	—	kΩ	
AD09	RVREF	ADC Voltage Reference Ladder Impedance	—	50	—	kΩ	**Note 3**

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Total Absolute Error is the sum of the offset, gain and integral non-linearity (INL) errors.

2: The ADC conversion result never decreases with an increase in the input and has no missing codes.

3: This is the impedance seen by the VREF pads when the external reference pads are selected.

APPENDIX A: DATA SHEET REVISION HISTORY

Revision A (07/2015)

Initial release of the document.

Revision B (10/2015)

Multiple register and bit name updates. Changed from an Advanced DS to a Preliminary DS.

Added Table 1 and 31-17.

Updated Register 6-7, 12-10, 12-11, 12-14, 12-15, 12-17 through 12-21, 12-25, 12-46, 12-51, 23-3, 23-5, 23-14, 23-22, and 26-3. Updated Section 10.0, 23.5.1, 33.0, 37.1. Updated Table 1-1, 8-1, 23-3, 23-4, 37-3, 37-5, 37-7, 37-8, 37-9, 37-11, 37-12, 37-14.

Revision C (01/2016)

Updated CCIO description of “Constant Current” to “Current Controlled” throughout document. Miscellaneous typos corrected.

Updated Cover page and Figure 27-1. Updated Register 32-6. Updated Table 37-17.

Revision D (4/2017)

Removed Preliminary Status - Added Char Graphs; Updated Figures 6-1, 23-2, 27-1, 28-1, 29-2, 29-3, 29-8, 29-9, 29-10, 29-11, 29-12, 29-13, 32-14, 32-15, 32-18, and 37-10; Registers 4-1, 4-3, 6-3, 8-2, 9-2, 12-2, 12-4, 12-6, 12-12, 12-14, 12-16, 12-32, 12-33, 12-34, 12-35, 12-36, 12-37, 12-43, 12-45, 12-49, 20-9, 23-1, 23-2, 23-3, 23-4, 27-2, 28-1, 28-3, 29-1, 31-4, 31-5, 31-6, 31-7, 34-1, and 34-2; Sections 9.1, 10.4.3, 21.5, 23.1.1, 23.1.4, 23.4.4, 23.5.2, 23.5.3, 29.1, 29.2, 31.6, 32.1.1, 32.6.9, 34.2, and 34.4; Tables 10-2, 20-2, 23-1, 31-3, 36-4, 37-3, 37.5, 37-11 and 37-13.

Added Figure 37-11. Added Section 6.2.2.4 MFINTOSC, 21.5.1 Correction by AC Coupling. Added Section 28.4: Timer1 16-Bit Read/Write Mode.

Updated Instruction Sets MOVWF and NOP.

Removed Figure 37-11.